DATA SHEET



MOS FIELD EFFECT TRANSISTOR

/NP88N055CHE, NP88N055DHE, NP88N055EHE

SWITCHING N-CHANNEL POWER MOS FET INDUSTRIAL USE

DESCRIPTION

These products are N-channel MOS Field Effect Transistor designed for high current switching applications.

FEATURES

- Channel temperature 175 degree rated
- Super low on-state resistance
- $R_{DS(on)} = 5.3 \text{ m}\Omega \text{ MAX.} (V_{GS} = 10 \text{ V}, \text{ ID} = 44 \text{ A})$
- Low C_{iss} : C_{iss} = 7600 pF TYP.
- Built-in gate protection diode

ABSOLUTE MAXIMUM RATINGS (TA = 25°C)

Drain to Source Voltage	VDSS	55	V
Gate to Source Voltage	Vgss	±20	V
Drain Current (DC) Note1	ID(DC)	±88	А
Drain Current (Pulse) Note2	D(pulse)	±352	А
Total Power Dissipation ($T_A = 25^{\circ}C$)	Ρτ	1.8	W
Total Power Dissipation (Tc = 25°C)	Рт	288	W
Single Avalanche Current Note3	las	65 / 88	А
Single Avalanche Energy Note3	Eas	422 / 15	mJ
Channel Temperature	Tch	175	°C
Storage Temperature	Tstg	-55 to +175	°C

Notes 1. Calculated constant current according to MAX. allowable channel temperature.

- **2.** PW \leq 10 μ s, Duty cycle \leq 1 %
- 3. Starting T_ch = 25°C, R_G = 25 Ω , V_Gs = 20 V \rightarrow 0 V (See Figure 4.)

THERMAL RESISTANCE

Channel to Case	Rth(ch-C)	0.52	°C/W
Channel to Ambient	Rth(ch-A)	83.3	°C/W

NP88N055DHE TO-262 NP88N055EHE TO-263

PART NUMBER

NP88N055CHE

ORDERING INFORMATION

(ТО-220АВ)

PACKAGE

TO-220AB

(TO-262)



(TO-263)

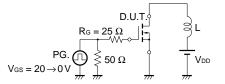


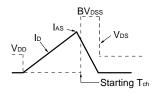
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ELECTRICAL CHARACTERISTICS (TA = 25°C)

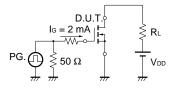
CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Drain to Source On-state Resistance	RDS(on)	V _{GS} = 10 V, I _D = 44 A		4.2	5.3	mΩ
Gate to Source Threshold Voltage	VGS(th)	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$	2.0	3.0	4.0	V
Forward Transfer Admittance	y _{fs}	V _{DS} = 10 V, I _D = 44 A	30	60		S
Drain Leakage Current	IDSS	Vds = 55 V, Vgs = 0 V			10	μA
Gate to Source Leakage Current	lgss	$V_{GS} = \pm 20 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$			±10	μA
Input Capacitance	Ciss	V _{DS} = 25 V		7600	11400	pF
Output Capacitance	Coss	V _G s = 0 V		1100	1700	pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		480	870	pF
Turn-on Delay Time	td(on)	ID = 44 A		42	93	ns
Rise Time	tr	$V_{GS(on)} = 10 V$		26	66	ns
Turn-off Delay Time	td(off)	$V_{DD} = 28 V$		120	240	ns
Fall Time	tr	$R_G = 1 \Omega$		32	81	ns
Total Gate Charge	QG	ID = 88 A		130	200	nC
Gate to Source Charge	Q _{GS}	$V_{DD} = 44 V$		31		nC
Gate to Drain Charge	Qgd	V _{GS} = 10 V		49		nC
Body Diode Forward Voltage	VF(S-D)	IF = 88 A, VGS = 0 V		1.0		V
Reverse Recovery Time	trr	IF = 88 A, VGS = 0 V		62		ns
Reverse Recovery Charge	Qrr	di/dt = 100 A/ μ s		120		nC

TEST CIRCUIT 1 AVALANCHE CAPABILITY

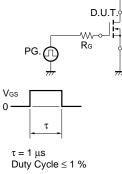


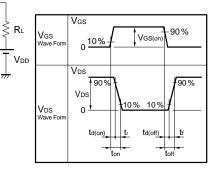


TEST CIRCUIT 3 GATE CHARGE



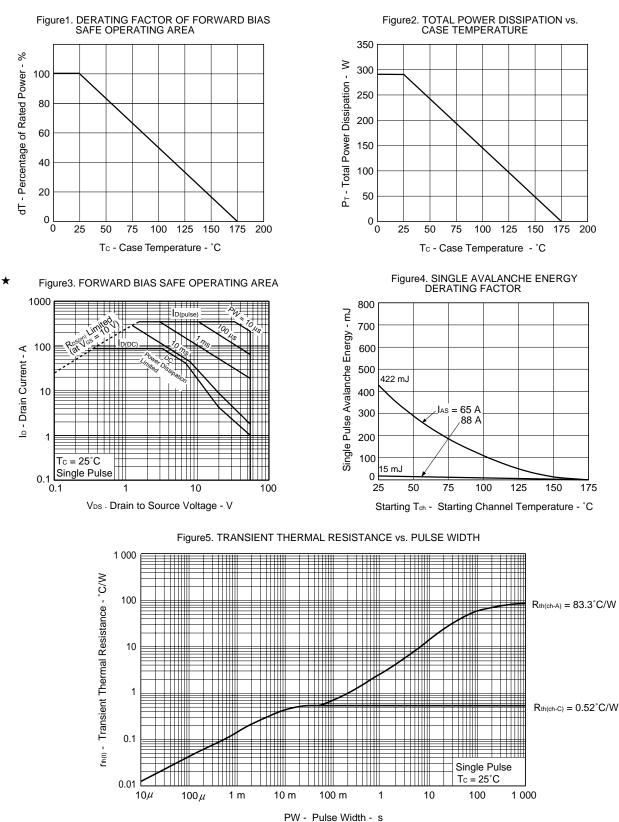
TEST CIRCUIT 2 SWITCHING TIME





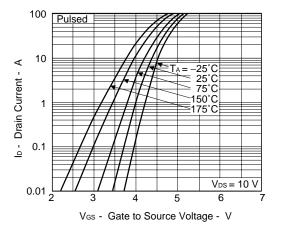
Data Sheet D14148EJ5V0DS

TYPICAL CHARACTERISTICS ($T_A = 25^{\circ}C$)

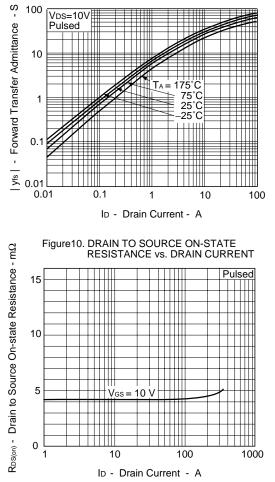


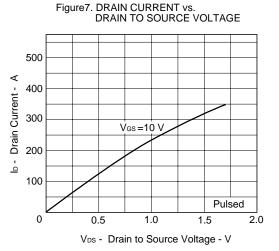
Data Sheet D14148EJ5V0DS

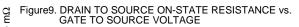
Figure6. FORWARD TRANSFER CHARACTERISTICS

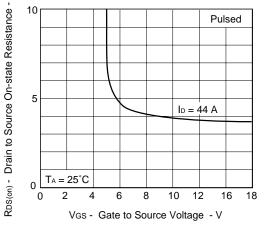




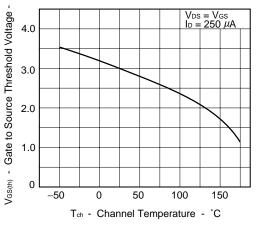


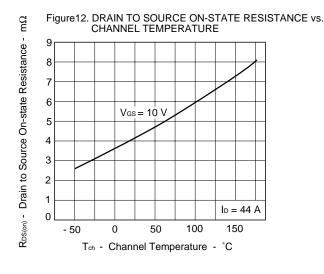












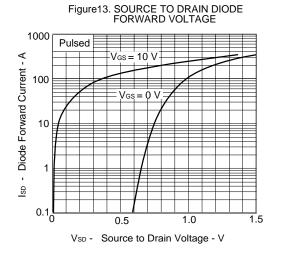


Figure 15. SWITCHING CHARACTERISTICS

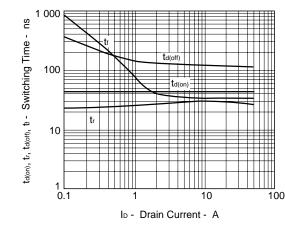
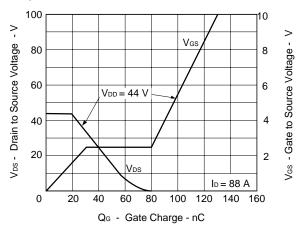
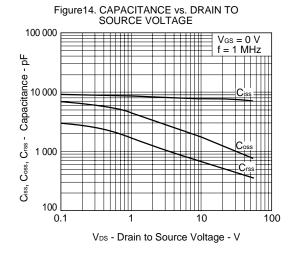
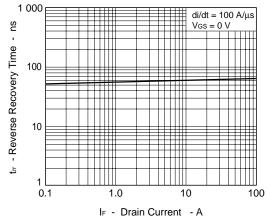


Figure17. DYNAMIC INPUT/OUTPUT CHARACTERISTICS





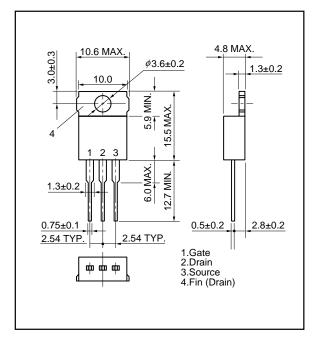


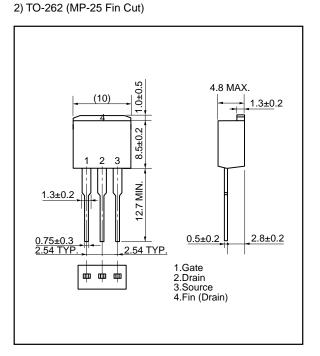


Data Sheet D14148EJ5V0DS

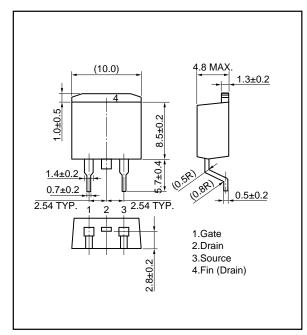
PACKAGE DRAWINGS (Unit: mm)

1) TO-220AB (MP-25)

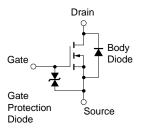




3) TO-263 (MP-25ZJ)



EQUIVALENT CIRCUIT



Remark The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

[MEMO]

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